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Modular Approval Letter

Date: 2023-06-13

FEDERAL COMMUNICATIONS COMMISSIONS

Authorization and Evaluation Division
7435 Oakland Mills Road
Columbia, MD 21046

We, Hangzhou Hylin IoT Technology Co., Ltd., hereby request Modular Approval for Product: LoRa SPI Module (Model number: HLM9S82), FCC ID: 2A4G5- HLM9S82). The EUT meets all of the requirements for modular approval as detailed in FCC 15.212. The requirements are described below:

1. The modular has RF shielding, please refer to the EUT photo.
2. The modular transmitter has buffered modulation/data inputs, Buffered data inputs stage has been integrated in chip (Model: LLCC68).
3. The modular transmitter has its own power supply regulation. Please refer to the schematic.
4. Comply with the antenna requirements of Section 15.203 and 15.204(c), the modular test with a dipole antenna which uses a unique type of connector to attach to the module, the maximum gain is 1.03dBi.
5. The EUT was tested in a stand-alone configuration, please refer to setup photos exhibit for details.
6. The module is labeled with its own FCC ID.
7. Comply with any specific rules or operating requirements that ordinarily apply to a complete transmitter and the manufacturer must provide adequate instructions along with the module to explain any such requirements. The necessary explanation to be complied with this requirement is contained in the user manual, and please refer to the User Manual.
8. Comply with FCC §15.247 (i) & §1.1307(b)(3)(i)(C) RF exposure requirements in its final configuration.

Sincerely,

Signature: 

Printed Name: Sean Xu

Title: CEO